



NGW75T65H3DF

650 V ,75 A high speed trench field-stop IGBT with full rated silicon diode

Rev. 1 — 28 June 2024

Product data sheet

1. General Description

The NGW75T65H3DF is a robust Insulated-Gate Bipolar Transistor (IGBT) featuring third-generation technology. It combines carrier stored trench-gate and field-stop (FS) structures. The NGW75T65H3DF is rated to 175 °C with optimized IGBT turn-off losses. This hard-switching 650 V, 75 A IGBT is optimized for high-voltage, high-frequency industrial power inverter applications.

2. Features and benefits

- Collector current (I_C) rated at 75 A
- Low conduction and switching losses
- Stable and tight parameters for easy parallel operation
- Maximum junction temperature of 175 °C
- Fully rated as a soft fast reverse recovery diode
- RoHS compliant, lead-free plating

3. Applications

- Power inverters
 - Uninterruptible Power Supply (UPS) inverter
 - Photovoltaic (PV) strings
 - EV charging
- Induction heating
- Welding

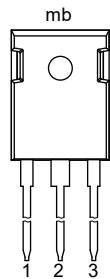
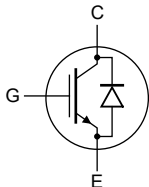
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CE}	collector-emitter voltage	$T_j = 25\text{ °C}$	-	650	V
T_j	operating junction temperature		-40	+175	°C

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		
2	C	collector		
3	E	emitter		
mb	C	mounting base; connected to collector		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
NGW75T65H3DF	TO-247-3L	Plastic single-ended through-hole package; heatsink mounted; 1 mounting hole; 3-lead TO-247-3L	SOT429-2

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
IGBT					
V _{CE}	collector-emitter voltage	T _j = 25 °C	-	650	V
I _C	collector current	T _{case} = 25 °C [1]	-	80	A
		T _{case} = 100 °C [1]	-	80	A
I _{Cpuls}	peak pulse collector current [2]		-	300	A
V _{GE}	gate-emitter voltage		-20	+20	V
P _{tot}	total power dissipation	T _{case} = 25 °C	-	600	W
		T _{case} = 100 °C	-	300	W
T _j	operating junction temperature		-40	+175	°C
T _{stg}	storage temperature		-55	+150	°C
T _{solder}	soldering temperature		-	260	°C
M	mounting torque, M3 screw		-	0.6	Nm
Diode					
I _F	diode forward current	T _{case} = 25 °C [1]	-	80	A
		T _{case} = 100 °C [1]	-	80	A
I _{Fpuls}	peak pulse diode current [2]			300	A

[1] Value limited by bond wire and T_{j(max)}.

[2] t_p limited by T_{j(max)}.

8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
R _{th(j-c)}	thermal resistance from junction to case	IGBT	-	0.21	0.25	K/W
		diode	-	0.33	0.39	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	-	40	K/W

9. Characteristics

Table 6. Characteristics

All values at T_j = 25 °C, unless otherwise specified.

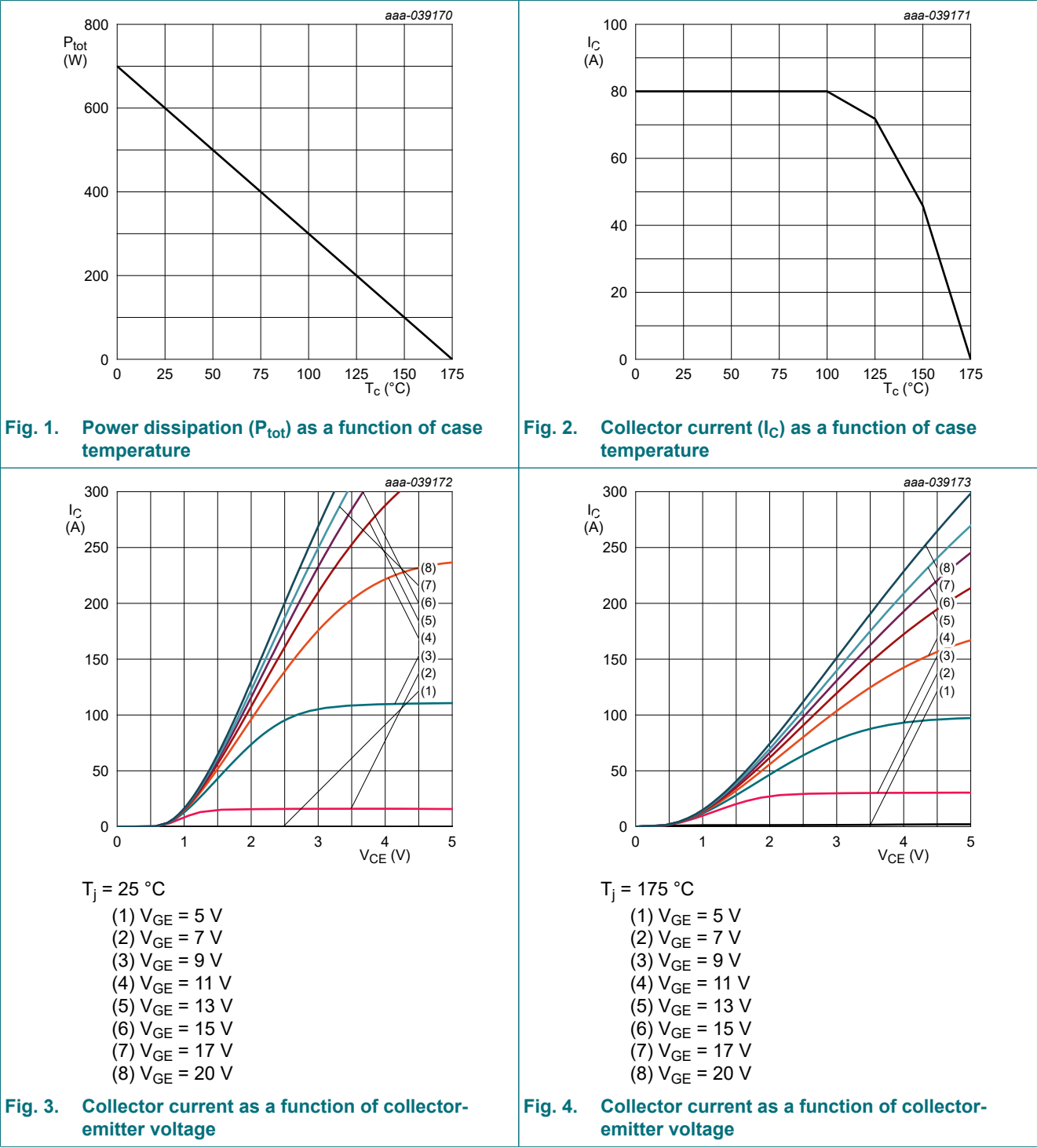
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
V _{(BR)CE}	collector-emitter breakdown voltage	V _{GE} = 0 V; I _C = 0.2 mA	650	-	-	V
V _{CEsat}	collector-emitter saturation voltage	V _{GE} = 15 V; I _C = 75 A; T _j = 25 °C	-	1.6	2	V
		V _{GE} = 15 V; I _C = 75 A; T _j = 175 °C	-	2.15	-	V
V _F	diode forward voltage	V _{GE} = 0 V; I _F = 75 A; T _j = 25 °C	-	1.45	1.9	V
		V _{GE} = 0 V; I _F = 75 A; T _j = 175 °C	-	1.3	-	V
V _{GE(th)}	gate-emitter threshold voltage	I _C = 0.75 mA; V _{CE} = V _{GE} ; T _j = 25 °C	4.3	5	5.7	V
I _{CES}	zero gate voltage collector current	V _{CE} = 650 V; V _{GE} = 0 V; T _j = 25 °C	-	20	-	nA
		V _{CE} = 650 V; V _{GE} = 0 V; T _j = 175 °C	-	1	-	mA
I _{GES}	gate-emitter leakage current	V _{CE} = 0 V; V _{GE} = 20 V	-	-	100	nA
g _{fs}	transconductance	V _{CE} = 20 V; I _C = 75 A; T _j = 25 °C	-	53	-	S
r _G	integrated gate resistor		-	0.7	-	Ω
Dynamic characteristics						
C _{ies}	input capacitance	V _{CE} = 25 V; V _{GE} = 0 V; f = 1 MHz	-	4200	-	pF
C _{oes}	output capacitance		-	265	-	pF
C _{res}	reverse transfer capacitance		-	19	-	pF
Q _G	gate charge	V _{CC} = 520 V; V _{GE} = 15 V; I _C = 75 A	-	160	-	nC
L _{sCE}	internal stray inductance	measured 5 mm from case	-	7.9	-	nH

650 V ,75 A high speed trench field-stop IGBT with full rated silicon diode

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
IGBT switching characteristics, inductive load							
t _{d(on)}	turn-on delay time	V _{GE} = 15/0 V; V _{CC} = 400 V; I _C = 75 A; r _{G(on)} = 10 Ω; r _{G(off)} = 10 Ω; see Fig. 27 and Fig. 28	T _J = 25 °C	-	29	-	ns
			T _J = 175 °C	-	27	-	ns
t _r	rise time		T _J = 25 °C	-	55	-	ns
			T _J = 175 °C	-	57	-	ns
t _{d(off)}	turn-off delay time		T _J = 25 °C	-	170	-	ns
			T _J = 175 °C	-	191	-	ns
t _f	fall time		T _J = 25 °C	-	48	-	ns
			T _J = 175 °C	-	49	-	ns
E _{on}	turn-on switching loss		T _J = 25 °C	-	2.9	-	mJ
			T _J = 175 °C	-	5.7	-	mJ
E _{off}	turn-off switching loss		T _J = 25 °C	-	1.1	-	mJ
			T _J = 175 °C	-	1.4	-	mJ
E _{ts}	total switching loss	T _J = 25 °C	-	4.0	-	mJ	
		T _J = 175 °C	-	7.1	-	mJ	
Diode switching characteristics, inductive load							
t _{rr}	diode reverse recovery time	V _R = 400 V; I _F = 75 A; ΔI _F /Δt = 500 A/μs; see Fig. 26	T _J = 25 °C	-	165	-	ns
			T _J = 175 °C	-	293	-	ns
Q _{rr}	diode reverse recovery charge		T _J = 25 °C	-	1610	-	nC
			T _J = 175 °C	-	7890	-	nC
I _{rrm}	diode peak reverse recovery current		T _J = 25 °C	-	23	-	A
			T _J = 175 °C	-	45	-	A
E _{rr}	reverse recovery energy		T _J = 25 °C	-	0.14	-	mJ
			T _J = 175 °C	-	0.88	-	mJ
di _{rr} /dt	diode peak rate or fall of reverse recovery current		T _J = 25 °C	-	450	-	A/μs
			T _J = 175 °C	-	280	-	A/μs

9.1. Waveforms and output characteristics

Table 7. Waveforms and output characteristics



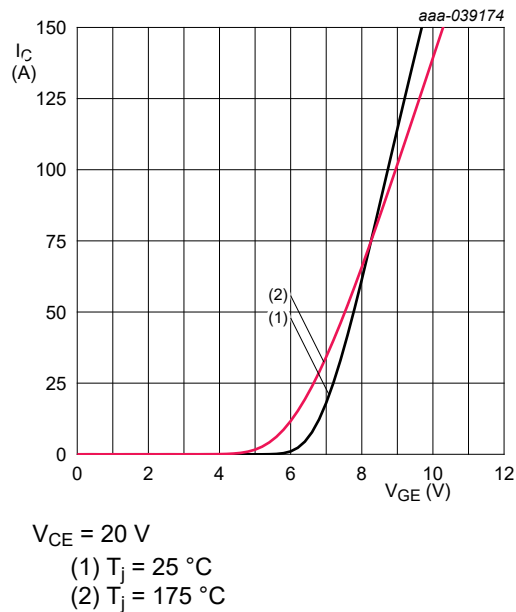


Fig. 5. Collector current as a function of gate-emitter voltage; typical values

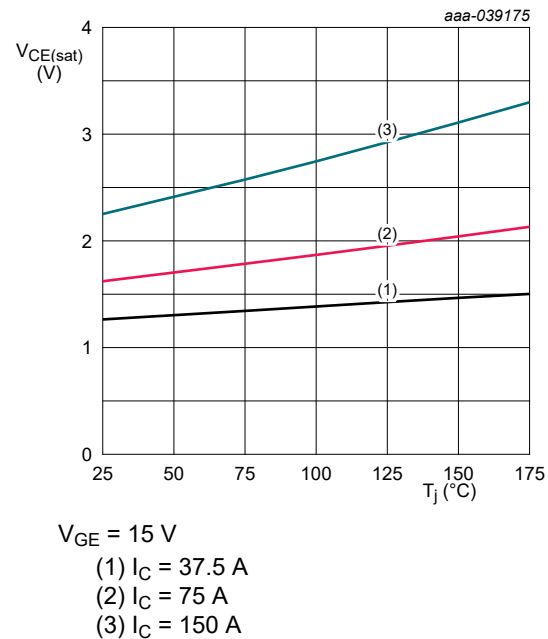


Fig. 6. Collector-emitter saturation voltage as a function of junction temperature; typical values

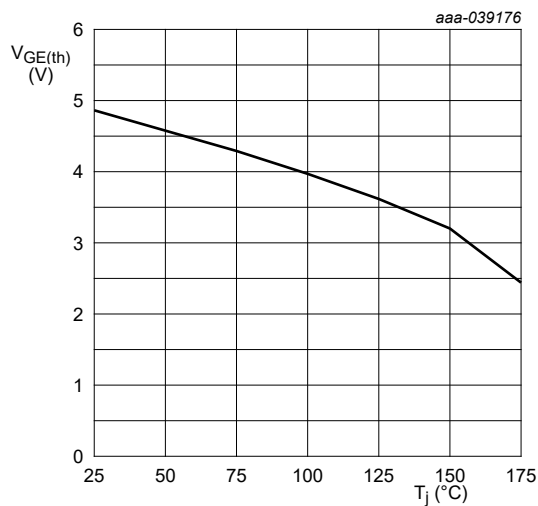


Fig. 7. Gate-emitter threshold voltage as a function of junction temperature

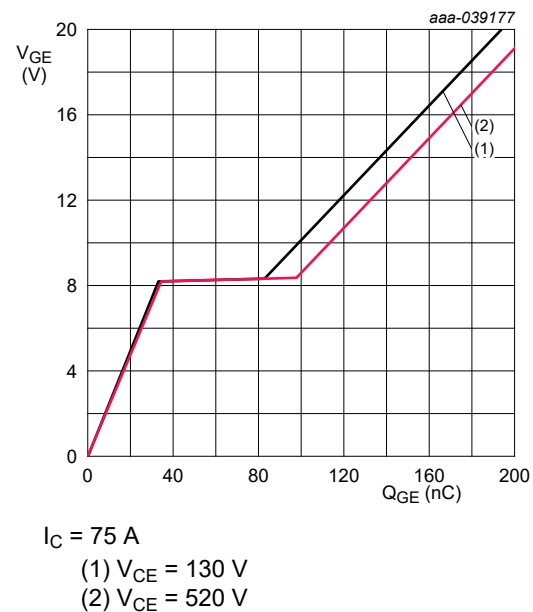
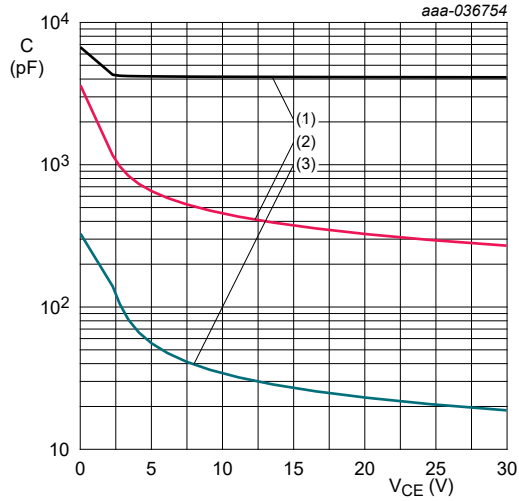


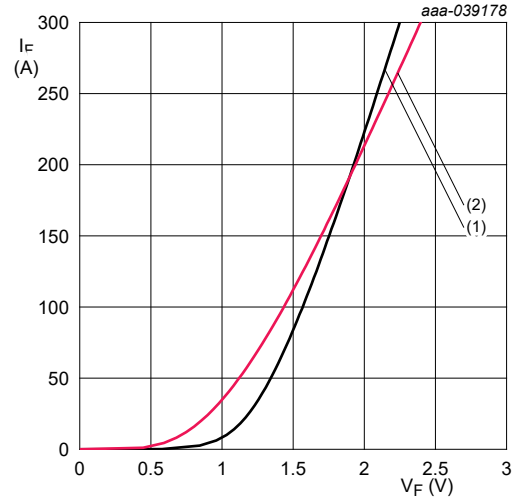
Fig. 8. Gate-emitter voltage as a function of gate charge; typical values



$V_{GE} = 0 \text{ V}$, $f = 1 \text{ MHz}$

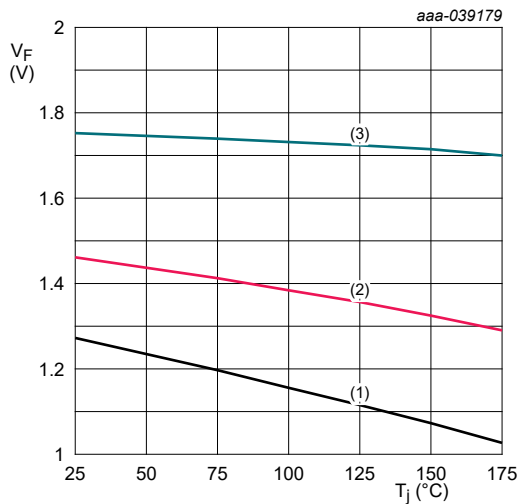
- (1) C_{ies}
- (2) C_{oes}
- (3) C_{res}

Fig. 9. Typical capacitance as a function of collector-emitter voltage



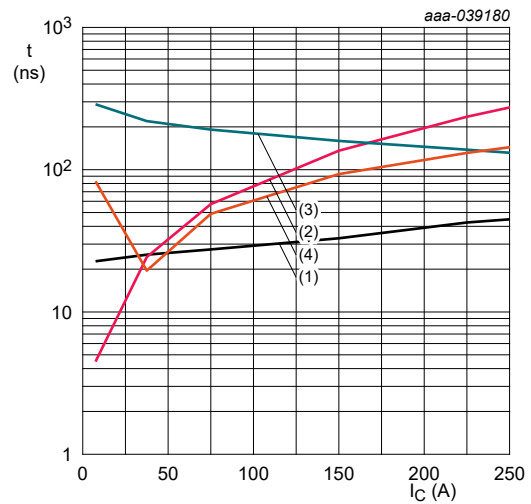
- (1) $T_{amb} = 25 \text{ °C}$
- (2) $T_{amb} = 175 \text{ °C}$

Fig. 10. Typical diode forward current as a function of forward voltage



- (1) $I_F = 37.5 \text{ A}$
- (2) $I_F = 75 \text{ A}$
- (3) $I_F = 150 \text{ A}$

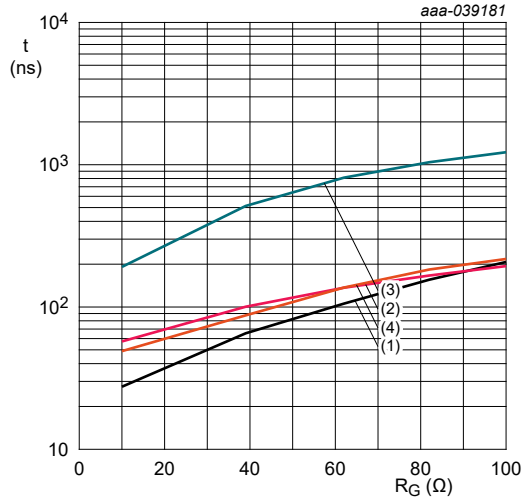
Fig. 11. Typical diode forward voltage as a function of junction temperature



$V_{GE} = 15 \text{ V to } 0 \text{ V}$; $V_{CC} = 400 \text{ V}$; $r_{G(on)} = 10 \text{ } \Omega$;
 $r_{G(off)} = 10 \text{ } \Omega$; $T_J = 175 \text{ °C}$

- (1) $t_{d(on)}$
- (2) t_r
- (3) $t_{d(off)}$
- (4) t_f

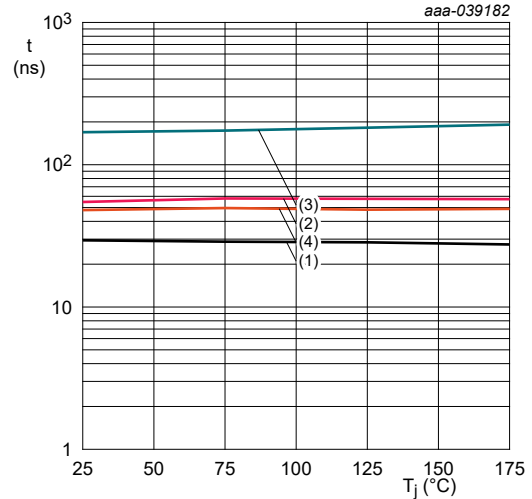
Fig. 12. Typical switching times as a function of collector current



$V_{GE} = 15 \text{ V to } 0 \text{ V}$; $V_{CC} = 400 \text{ V}$; $I_C = 75 \text{ A}$;
 $T_j = 175 \text{ }^\circ\text{C}$

- (1) $t_{d(on)}$
- (2) t_r
- (3) $t_{d(off)}$
- (4) t_f

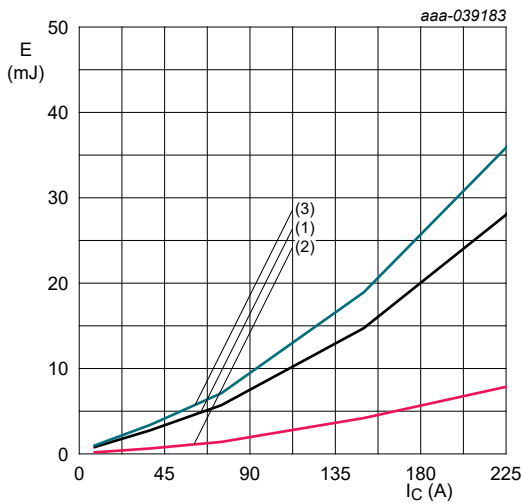
Fig. 13. Typical switching times as a function of gate resistor



$V_{GE} = 15 \text{ V to } 0 \text{ V}$; $I_C = 75 \text{ A}$; $V_{CC} = 400 \text{ V}$;
 $r_{G(on)} = 10 \text{ } \Omega$; $r_{G(off)} = 10 \text{ } \Omega$

- (1) $t_{d(on)}$
- (2) t_r
- (3) $t_{d(off)}$
- (4) t_f

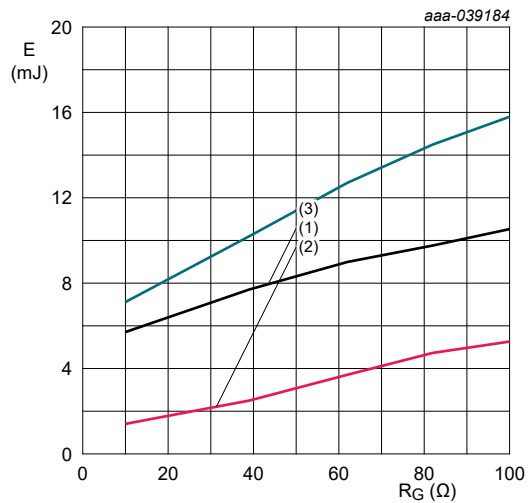
Fig. 14. Typical switching times as a function of junction temperature



$V_{GE} = 15 \text{ V to } 0 \text{ V}$; $V_{CC} = 400 \text{ V}$; $r_{G(on)} = 10 \text{ } \Omega$;
 $r_{G(off)} = 10 \text{ } \Omega$; $T_j = 175 \text{ }^\circ\text{C}$

- (1) E_{on}
- (2) E_{off}
- (3) E_{ts}

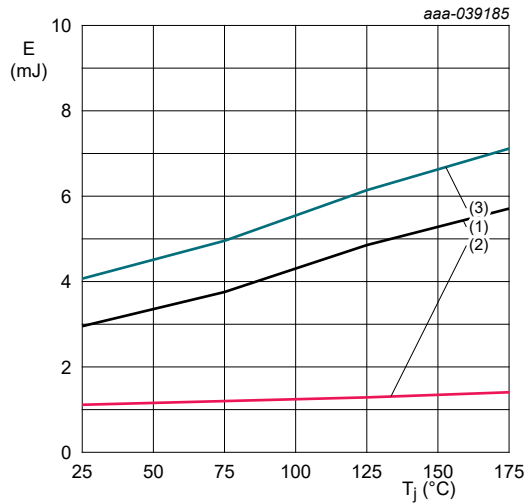
Fig. 15. Typical switching energy losses as a function of collector current



$V_{GE} = 15 \text{ V to } 0 \text{ V}$; $V_{CC} = 400 \text{ V}$; $I_C = 75 \text{ A}$;
 $T_j = 175 \text{ }^\circ\text{C}$

- (1) E_{on}
- (2) E_{off}
- (3) E_{ts}

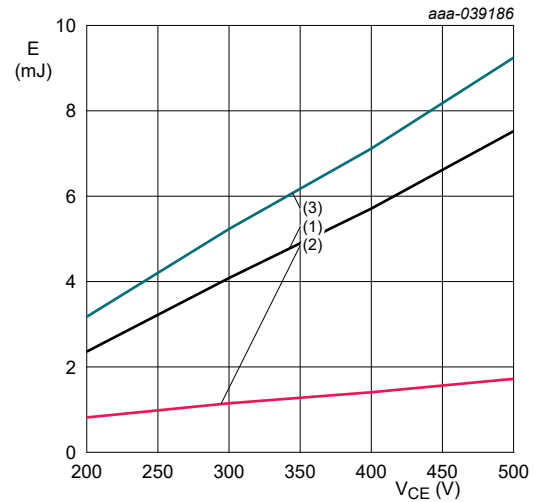
Fig. 16. Typical switching energy losses as a function of gate resistance



$V_{GE} = 15 \text{ V to } 0 \text{ V}$; $I_C = 75 \text{ A}$; $V_{CC} = 400 \text{ V}$;
 $r_{G(on)} = 10 \text{ } \Omega$; $r_{G(off)} = 10 \text{ } \Omega$

- (1) E_{on}
- (2) E_{off}
- (3) E_{ts}

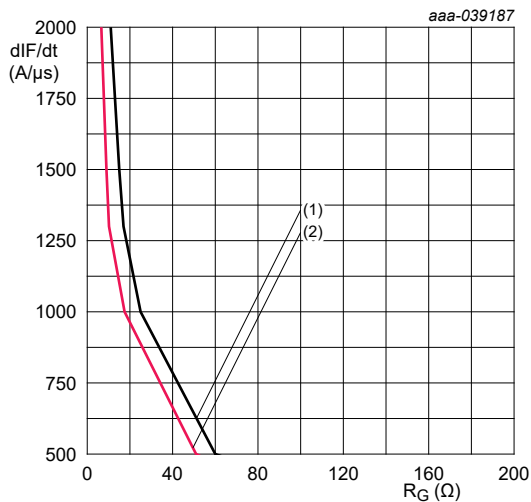
Fig. 17. Typical switching energy losses as a function of junction temperature



$V_{GE} = 15 \text{ V to } 0 \text{ V}$; $I_C = 75 \text{ A}$; $r_{G(on)} = 10 \text{ } \Omega$; $r_{G(off)} = 10 \text{ } \Omega$; $T_j = 175 \text{ } ^\circ\text{C}$

- (1) E_{on}
- (2) E_{off}
- (3) E_{ts}

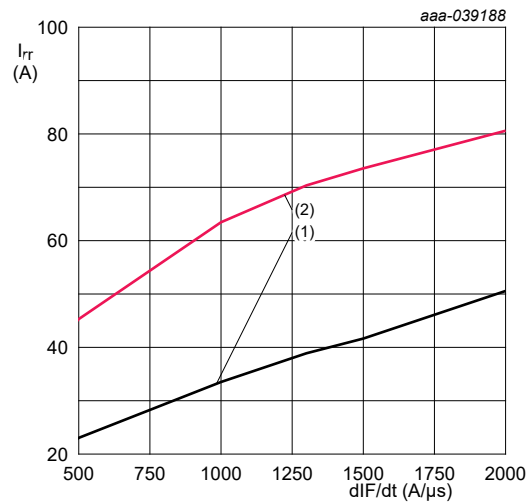
Fig. 18. Typical switching energy losses as a function of collector-emitter voltage



$V_R = 400 \text{ V}$; $I_F = 75 \text{ A}$

- (1) $T_{amb} = 25 \text{ } ^\circ\text{C}$
- (2) $T_{amb} = 175 \text{ } ^\circ\text{C}$

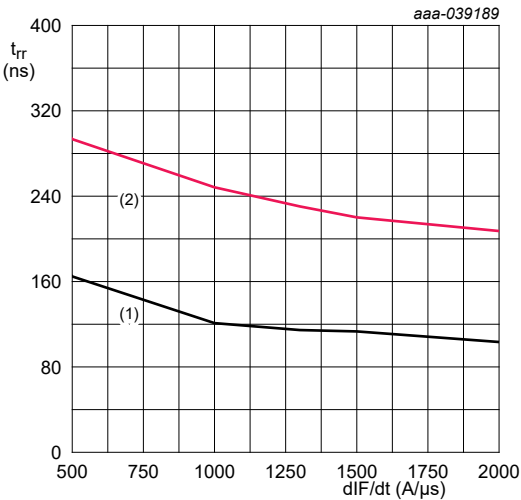
Fig. 19. Typical change of forward current as a function of gate resistor



$V_R = 400 \text{ V}$; $I_F = 75 \text{ A}$

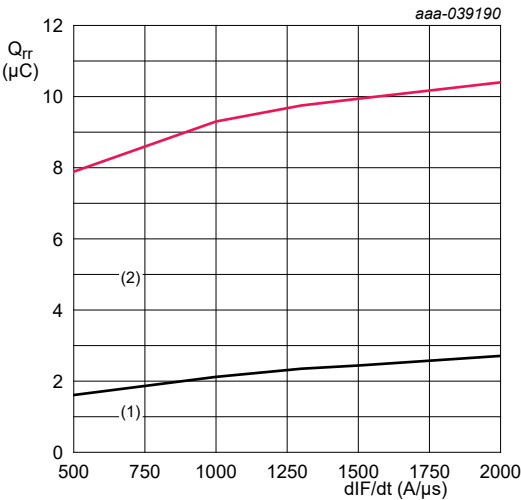
- (1) $T_{amb} = 25 \text{ } ^\circ\text{C}$
- (2) $T_{amb} = 175 \text{ } ^\circ\text{C}$

Fig. 20. Typical reverse recovery current as a function of change of forward current



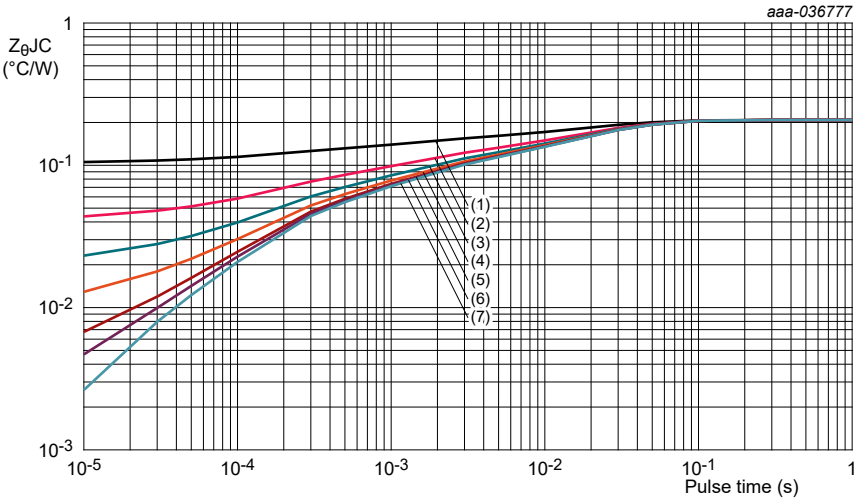
$V_R = 400\text{ V}; I_F = 75\text{ A}$
(1) $T_{\text{amb}} = 25\text{ }^{\circ}\text{C}$
(2) $T_{\text{amb}} = 175\text{ }^{\circ}\text{C}$

Fig. 21. Typical reverse recovery time as a function of rate of change of forward current



$V_R = 400\text{ V}; I_F = 75\text{ A}$
(1) $T_{\text{amb}} = 25\text{ }^{\circ}\text{C}$
(2) $T_{\text{amb}} = 175\text{ }^{\circ}\text{C}$

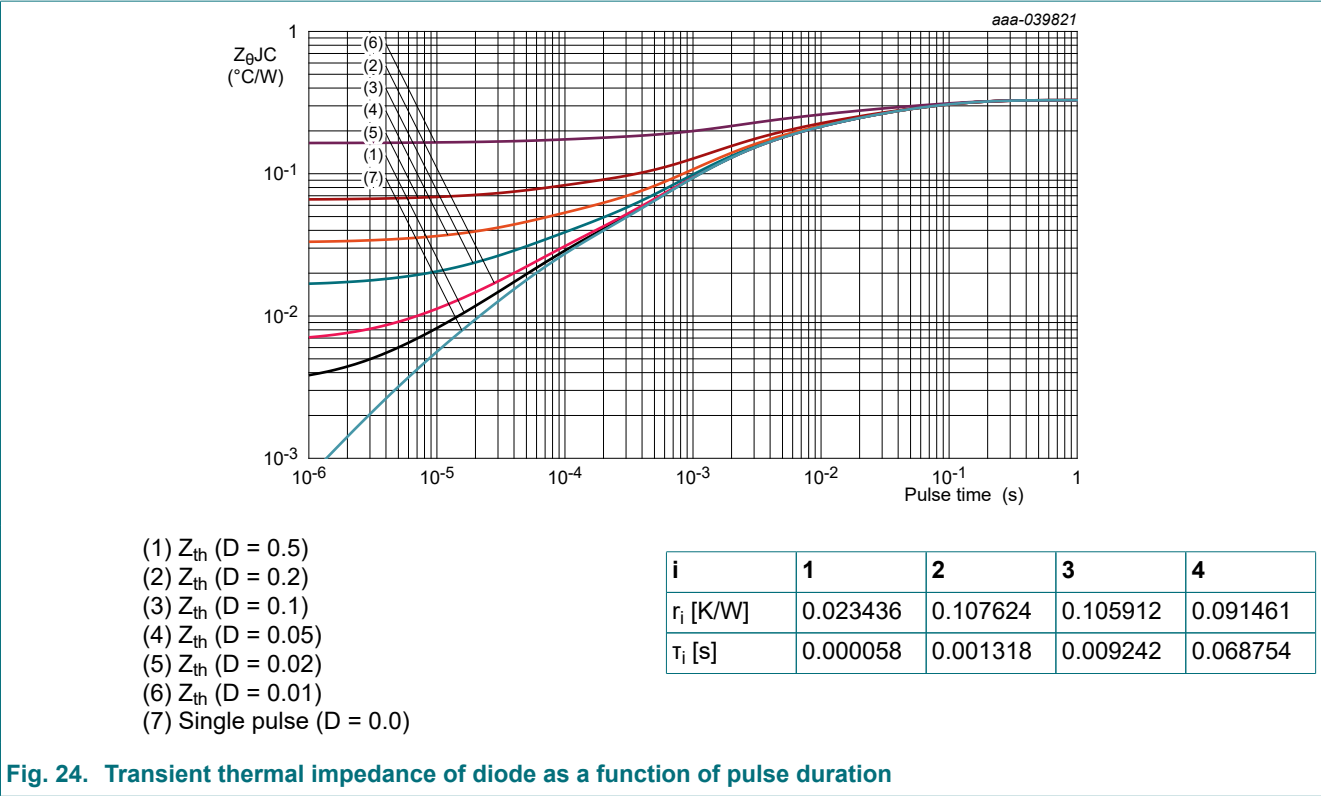
Fig. 22. Typical reverse recovery charge as a function of rate of change of forward current



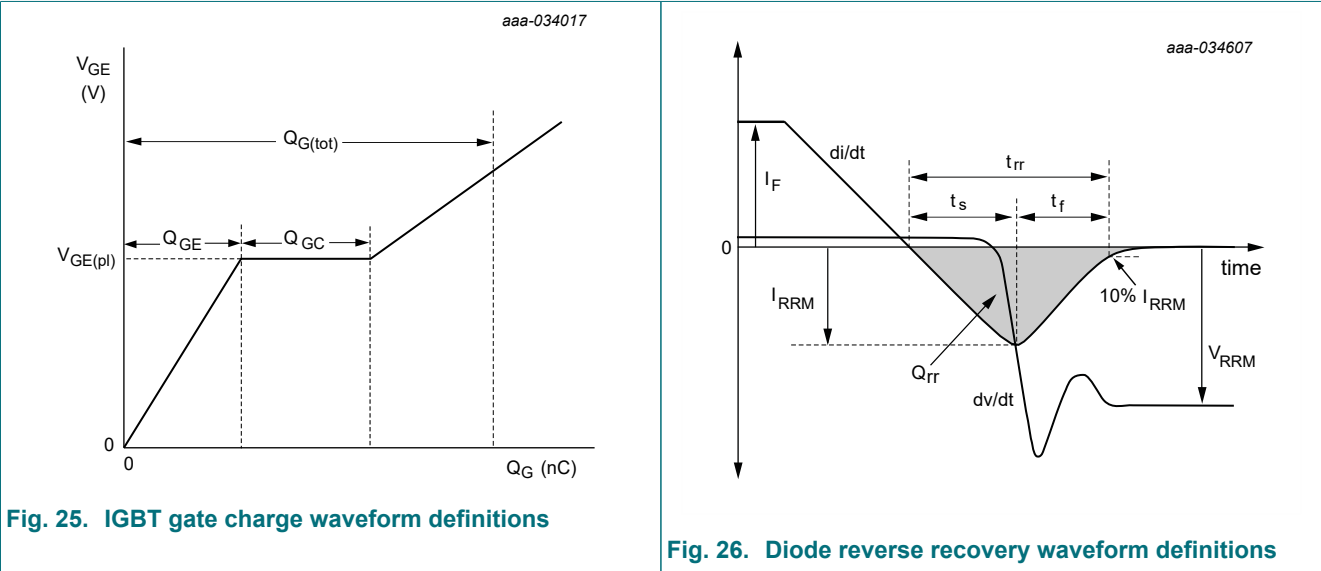
- (1) Z_{th} ($D = 0.5$)
- (2) Z_{th} ($D = 0.2$)
- (3) Z_{th} ($D = 0.1$)
- (4) Z_{th} ($D = 0.05$)
- (5) Z_{th} ($D = 0.02$)
- (6) Z_{th} ($D = 0.01$)
- (7) Single pulse ($D = 0.0$)

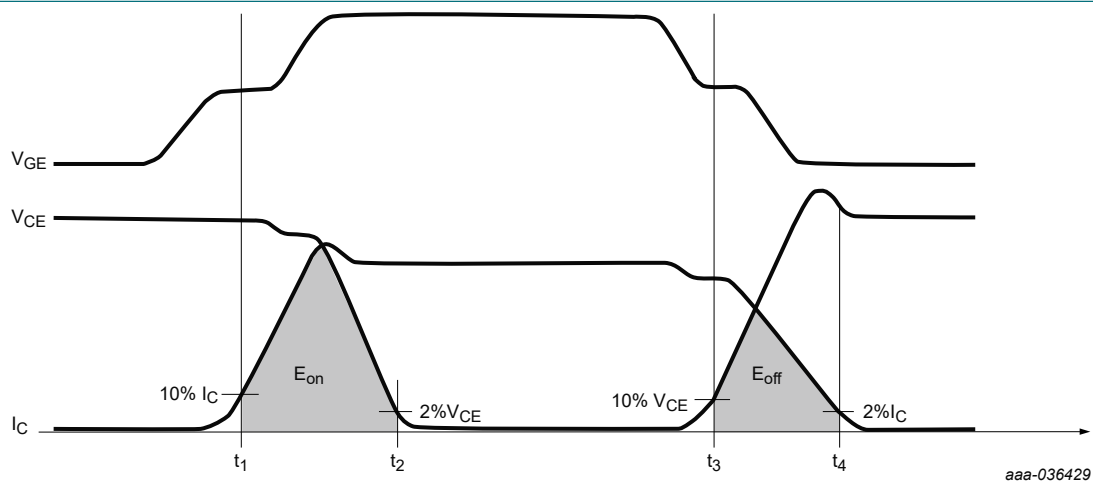
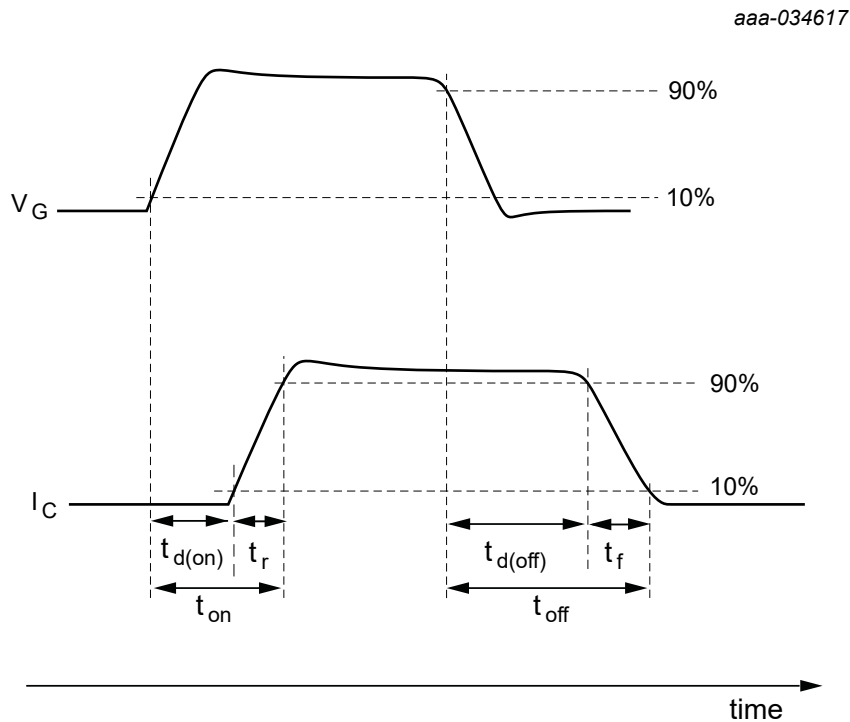
i	1	2	3	4
r_i [K/W]	0.027464	0.045430	0.036075	0.099107
T_i [s]	0.000138	0.000757	0.004623	0.027935

Fig. 23. Transient thermal impedance of IGBT as a function of pulse duration



9.2. Waveforms





10. Package outline

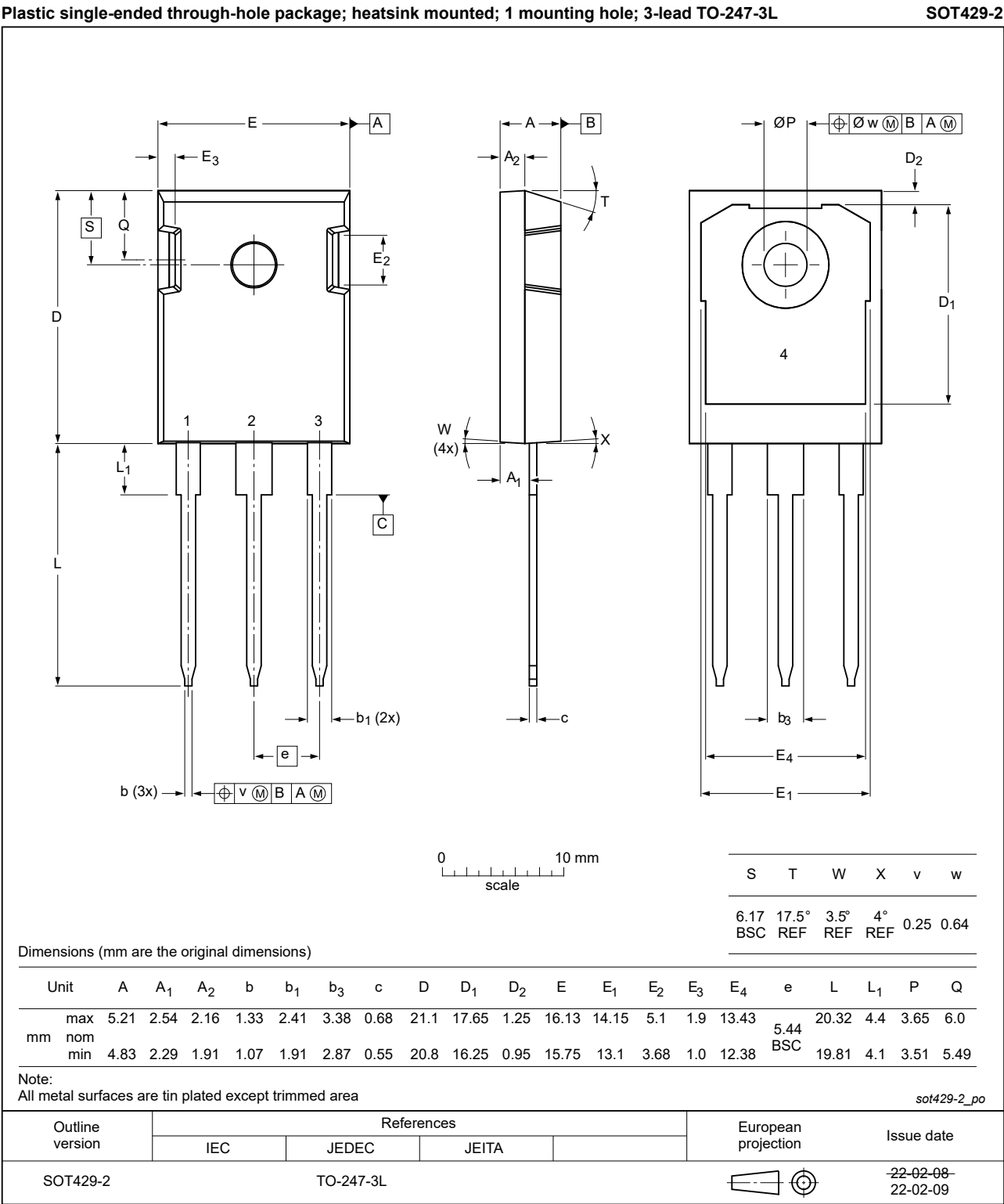


Fig. 29. Package outline TO-247-3L (SOT429-2)

11. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NGW75T65H3DF v. 1	20240628	Product data sheet	-	-

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Contents

1. General Description.....1

2. Features and benefits..... 1

3. Applications..... 1

4. Quick reference data..... 1

5. Pinning information.....2

6. Ordering information.....2

7. Limiting values..... 2

8. Thermal characteristics..... 3

9. Characteristics.....3

9.1. Waveforms and output characteristics.....5

9.2. Waveforms..... 11

10. Package outline..... 13

11. Revision history..... 14

12. Legal information.....15

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